N um erical study of hydrogenic e ective m ass theory for an im purity P donor in Si in the presence of an electric eld and interfaces

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In this paper we exam ine the e ects of varying several experimental parameters in the K ane quantum computer architecture: A -gate voltage, the qubit depth below the silicon oxide barrier, and the back gate depth to explore how these variables a ect the electron density of the donor electron. In particular, we calculate the resonance frequency of the donor nuclei as a function of these parameters. To do this we calculated the donor electron wave function variationally using an e ective m ass H am iltonian approach, using a basis of deform ed hydrogenic orbitals. This approach was then extended to include the electric eld H am iltonian and the silicon host geometry. We found that the phosphorous donor electron wave function was very sensitive to all the experimental variables studied in our work, and thus to optim ise the operation of these devices it is necessary to control all parameters varied in this paper.

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I. IN TRODUCTION

Since Kohn and Luttinger's^{1,2} original work on shallow donors in silicon, there has been renewed interest in the study of donor in purities in silicon, particularly the Si:³¹P system , follow ing K ane's³ proposal for a solidstate quantum computer. In the Kane quantum computer, information is encoded onto the nuclear spins of donor phosphorous atom s in doped silicon electronic devices. Application of an electrostatic potential at surface electrodes positioned above the qubits (A-Gates) tunes the resonance frequency of individual spins, while surface electrodes between qubits (J-Gates) induces electronm ediated coupling between nuclear spins. Perturbing the donor electron density with an externally applied electric eld is crucial in tuning the hyper ne interaction between the donor electron and nucleus and hence also in tuning the resonance frequency of the P nuclei and controlling logical operations. Substantial theoretical efforts have been devoted to m odeling the P donor electron ground state in the silicon wafer device, and the altered ground state with an externally applied electric eld. In this paper we discuss relevant experim ental param eters which can be controlled to perturb the donor electron wave function.

There is a considerable amount of work done in this area, and several theoretical approaches have been pursued with varying degrees of application and approximation. In Kohn and Luttinger's^{1,2} work, the P donor ground state in the bulk silicon is calculated using a single trialwave function: a deform ed 1S hydrogenic orbital and varying the Bohr radii to minim ise the ground state energy. In this paper we follow Faulkner's⁴ approach and extend Kohn's method to include a trial wave function expanded in a basis of deform ed hydrogenic orbitals, and vary the Bohr radii to m in im ise the ground state energy. As we have used a large basis set in this approach, the ground state wave function has the exibility to distort with the application of an electric eld above the P donor. Several authors 5,6,7 have previously investigated the effects induced by strain and interface regions on donor states. These external in uences partially lift the valley degeneracy in the bulk silicon.

The e ect of an electric eld potential at a gate above a P donor in a silicon substrate on the hyper ne interaction coupling between the P donor electron and nucleus has already been reported by several authors. In the work of K ane⁸ and Larinov et al.⁹ the e ect of an electric

eld potential in the bulk silicon host is considered using perturbative theory, excluding the additional interface potentials. W ellard et al.¹⁰ consider both the in uence of the electric eld and interface barriers using a spherical e ective m ass H am iltonian.

The main advantage dem onstrated in our approach using the anisotropic basis is the exibility in choosing the smaller elective Bohr radius for the donor ground state to be in the direction towards the interface regions. This minimizes the overlap of the donor wave function into these regions. For shallow donor depths, the donor wave function is restricted in moving towards the A-gate because of the silicon oxide interface.

In this work, we include the e ects of both the electric eld potential and the interface regions, and the anisotropy of the conduction band m inimum in Si. To our know ledge, there have been hitherto no published results for m odeling electrostatic gate operations in the K ane quantum computer which include simultaneously the anisotropy of the e ective m asses in the silicon host, the electric eld potential and the interface regions in the Siw afer device. In this paper we address all these criteria and discuss relevant experim ental param eters which can be adjusted to ne tune the contact hyper ne interaction. W e calculate this coupling as a function of A-gate voltage, donor depth below associated A-gate and the back gate depth. A subsequent paper will discuss our further results for the J-gate controlled electron exchange interaction between adjacent donor electrons.

In Sec. II, we will discuss some background e ective m ass theory and the approach we took to obtain the phosphorous donor ground state in bulk silicon with no electric eld applied. Section III discusses how we obtained the electric eld potential and modeled the silicon host geom etry to include the silicon oxide layer and back gate. The num erical results using the m ethods outlined in the previous sections are presented in Sec. IV for the varying experim ental param eters studied. Finally we sum marise our major notings in Sec.V.

II. FAULKNER'S METHOD

N eglecting inter-valley terms, the one-valley e ective mass equation for the energy levels of donors in silicon is given below 4

$$\frac{\sim^2}{2m_{?}} \quad \frac{\varrho^2}{\varrho x^2} + \frac{\varrho^2}{\varrho y^2} + \frac{\sim^2}{2m_k} \frac{\varrho^2}{\varrho z^2} + \frac{e^2}{r} \quad (r) = E \quad (r);$$
(1)

where = 11:4 is the dielectric constant, and m_2 = 0:1905m₀ and m_k = 0:9163m₀ are the transverse and longitudinal e ective m asses respectively, and m_0 is the m assofa free electron. Here we are expanding the energy, E_k^0 around the conduction band m in imum along the z-axis at $\tilde{k} = (0;0;k_0)$:

$$E_{k}^{0} = E_{0}^{0} + \frac{2}{2m_{2}} k_{x}^{2} + k_{y}^{2} + \frac{2m_{k}}{2m_{k}} k_{z}^{2} - k_{0}^{2}$$
 : (2)

We followed Faulkner's approach and kept the full anisotropy of the conduction band minimum. We expanded the donor electron wave function, (r) in a basis of deform ed hydrogenic orbitals:

(r) =
$$\begin{array}{c} X & 1=4 \\ - & n \ln (x;y; -z;a); \\ n \ln & \end{array}$$

where $n_{\rm lm}$ (x;y;z;a) = $R_{\rm nl}$ (a;r) $Y_{\rm lm}$ (;) are the normalised hydrogenic orbitals, = $m_{\rm 2} = m_{\rm k} = 0.2079$, a is the e ective Bohr radius in the x;y directions, and is an adjustable parameter which gives the e ective Bohr radius b in the z direction.

If we use atom ic units, where the unit of length $a_b = -2^2 = m_2 e^2 = 31.7A$ and unit of energy $m_2 e^4 = 22^{-2} = -2^{$

1.6 $|\Psi|^2$ in z direction -----x,y directions 1.4 isotropic basis 1.2 1 a = 2.38nm $|\Psi|^2$ 0.8 b = 1.37nm P at origin 0.6 0.4 = 3.17nm 0.2 0 5 10 -10 -5 0 r (nm)

FIG.1: G round state electron density without electric eld.

19:94m eV, Eq. (1) becom es:

$$\frac{\theta^2}{\theta x^2} + \frac{\theta^2}{\theta y^2} + \frac{\theta^2}{\theta z^2} + \frac{2}{r} \qquad (r) = E \quad (r);$$
(3)

Equation (3) was diagonalised with the elective Bohr radius a and parameter varied to minimise the ground state energy E. The ground state energy converged using a basis of 91 hydrogenic orbitals to give $E = p\frac{31.23m}{(=)}a = 13.68A$. These results are consistent with K ohn's results of a = 25A and b = 14.2, $A^{1,2}$ and Faulkner's ground state energy $E = 31.27m eV^4$ for phosphorous.

The ground state wave function obtained was a deformed hydrogenic 1S orbital. Figure 1 shows the ground state electron density plotted in the x; y and z directions for comparison of the di erent e ective Bohr radii obtained in the di erent directions. A lso shown in this gure is the ground state obtained using a spherical ective m ass H am iltonian and isotropic hydrogenic orbitals as a basis, here the e ective electron m ass is given by m m₂ = 0:1905m₀, which gives an e ective Bohr radius of 3.17nm.

III. INCLUDING THE ELECTRIC FIELD AND SILICON HOST POTENTIAL

Faulkner's method was then extended to include the e ects of an electric eld above the qubit, and boundary conditions of the silicon host. The solution of Poisson's equation to extract the electric eld potential for our device with the A-gate at varying voltages was obtained by simulation using a Technology Computer Aided Design (TCAD) modeling package.¹²

TCAD is used in the electronics industry as a tool for 2-D and 3-D modeling and simulation of sem iconductor

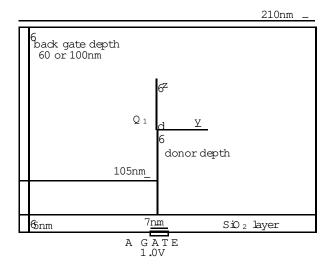


FIG.2: Schem atic design param eters im plem ented in TCAD to m odel the K ane com puter architecture.

devices. It employs a coupled New ton-like solver at discrete nodes to obtain the self-consistent solution of the Poisson and electron-hole continuity equations. Figure 2 shows the 2-D device scheme implemented in TCAD used to model the application of a voltage to the A-gate above qubit, Q₁. The lateral edges of the silicon lattice were assumed to extend in nitely in the y-direction, but the electrostatic potential was only obtained on a nite grid 210nm wide, with the potential set to zero outside this region. We checked that this approximation is valid at the boundaries and found the TCAD potential had fallen close to zero (10⁴ 10⁵ eV), at y = 105nm. The potential in 2-D from TCAD is assumed to have a \thickness" in the third dimension (x) of 1 m.

In this paper we exam ine the e ects of varying several experimental parameters: A -gate voltage, qubit depth below the silicon oxide barrier, and the back gate depth to explore how these variables a ect the electron density of the donor electron at the phosphorous nuclei. In particular we calculate the resonance frequency of the donor nucleus as a function of these parameters.

The application of a potential, and the silicon host geom etry in the device shown in Fig.2 splits the degeneracy of the two localm inim a along the z-axis, compared to the other four along the x and y axis in the low er A₁ ground state.⁵ W ith no electric eld applied the ground state wave function is > 99% 1S in character. When the voltage applied is low enough so that the wavefunction stays predom inantly 1S in character, diagonalising the single valley e ective mass equation is equivalent for solving in either valley, z, since the deform ed 1S wavefunction is symmetric in z.⁶

U sing these justications we can formulate the problem using a co-ordinate system with the z-axis in the direction from Q_1 to the interface. With this convention we expand the donor wave function around the conduction band minimum oriented along the z-axis. Because of the smaller elective Bohr radius in the z direction towards the interface and back gate, the ground state is lower in energy since there is less penetration of the wave function into these barrier regions.

W ith the electric eld the Hamiltonian is: $H = H_0 + H_1$, where H_0 is the zero eld Hamiltonian, and $H_1 = V(y;z)$ is the electric eld potential term . V(y;z) is the electric eld potential generated from TCAD, and here we also add an additional term to model the SiO₂ layer and the back gate. The Si=SiO₂ barrier was modeled as a step function with height 3.25eV, since most insulators have a work function greater than 3eV.¹¹ The back gate serves as a reference voltage point (ground) to the voltages applied to the top gates. O utside the back gate the potential was set at 3.25eV also.

To calculate the perturbed donor electron wave function and energies we constructed the electric eld H am iltonian m atrix, H₁, with its elements given by:

The integrals in Eq. (4) were then calculated num erically for the varying voltages at the A-gate and qubit position. Once H_1 was obtained the total H am iltonian was then diagonalised to nd the donor electron ground state with the varying experimental parameters.

IV. NUMERICAL RESULTS

A . Results obtained varying A-gate voltage and donor depth

The perturbed donor electron ground state was calculated for each set of experim ental parameters to compare and optim ise the conditions for addressing the target qubit, Q_1 . Once the electron ground state was found we calculated the value of the contact hyper ne coupling A (V) for each particular voltage at the A-gate and qubit depth below this gate.

The general form ula for the contact hyper ne coupling A (V) is given below :

$$A(V) = \frac{2}{3} B g_{N N} O j (V;0) j; \qquad (5)$$

where (V;0) is the donor electron ground state wave function evaluated at the donor nucleus, $_{\rm B}$ is the Bohr m agneton, $g_{\rm N}$ is Lande's factor for 31 P, $_{\rm N}$ is the nuclear m agneton and $_{0}$ is the permeability of free space.^{9,10}

Since we use e ective m ass theory, instead of calculating the donor wave function with the full expansion of the B loch functions, we calculate the envelope function,

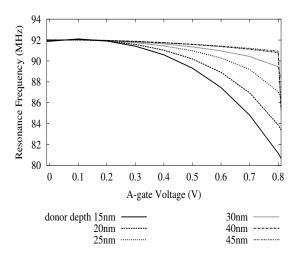


FIG. 3: Nuclear resonant frequency shifts of qubit Q_1 at lower voltages with varying donor depths, back gate depth at 60nm, using anisotropic basis.

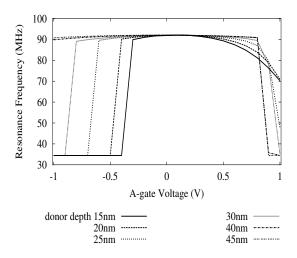


FIG. 4: Nuclear resonant frequency shifts of qubit Q_1 at varying voltage and donor depth, back gate depth at 60nm, using anisotropic basis.

which describes the sm ooth donor-related m odulation of the electron wave-function. So instead of calculating the contact hyper ne coupling, A (V), directly we calculate the relative shift in A (V) with the potential applied and assume this shift will be similar to those of the true wave function.¹⁰ Thus we need to calculate:

$$A(V) = \frac{j(V;0)j}{j(0;0)j}A(0);$$
(6)

where A (0)=h = 28:76M Hz is determ ined for ³¹P in silicon from experim entaldata,^{3,9} and (V;r) are the donor envelope wave functions calculated by our m ethod.

The phosphorous nuclear resonant frequency is a ected by the donor electron when the valence electron is spin polarized by a background magnetic eld, B, of the order of 2T. The hyper ne interaction constant is related to the frequency separation of the nuclear levels, via the following equation (accurate to second order):

h =
$$2q_{N}$$
 N B + $2A + \frac{2A^2}{{B}B}$: (7)

In all the calculations we considered the background m agnetic eld xed at 2T.Figure 3 shows the nuclear resonant frequency shift of Q_1 , calculated for a lower range of positive A-gate voltages, between 0V and 0.8V, for the varying donor depths below the silicon oxide barrier. Figure 4 shows the nuclear resonant frequency shift calculated for the full range of A-gate voltages, between

1:0V and 1:0V, for the varying donor depths below the silicon oxide barrier. These plots are calculated with a close back gate depth set at 60nm

For comparison of our method with previous results¹⁰ reported using a spherical e ective mass Ham iltonian, we calculated the resonance frequency of Q_1 using an isotropic e ective Bohr radius of 3nm. Our results were consistent with the calculations of W ellard et al.¹⁰ The results for the isotropic basis showed that for donor depths close to the silicon oxide barrier, the wave function was restricted in moving towards the applied A -gate voltage. The donor wave function obtained using the anisotropic basis, is advantageous because of the smaller e ective Bohr radius in the direction toward the silicon oxide layer, which results in less penetration of the donor wave function into the interface regions. Thus the an isotropic basis produced a more energetically favorable ground state than the isotropic ground state.

For the lower voltages (0:8V), the results are consistent with the expectation that the closer the donor depths are to the applied voltage, the greater the frequency shift. At voltages above a certain threshold and donor depths further away from the silicon oxide barrier, there is a huge di erence in the donor wave function from the zero eld ground state, as it is perturbed alm ost com pletely away from the nucleus. Figure 5 shows an exam ple of this change in electron density for a voltage of 1.0V at the A-gate and donor depth of 40nm. Here the P nucleus is at the origin and as z decreases the electric eld increases.

In Fig. 6 and 7 we observe the di erence in the donor electron ground state obtained for a donor depth of 20 and 40nm with a positive voltage of 1.0V at the A-gate. In both these plots the donor wave function moves toward the applied A-gate voltage in the negative z direction. For a close donor depth of 20nm we observe that even though the donor wave function moves slightly toward the A-gate, it is signin cantly restricted in moving in this direction because of the silicon oxide interface in this direction also. In contrast the donor wave function for a depth of 40nm deform s unhindered toward the A-gate, and most of the electron density has been transform ed away from the nucleus.

Figure 8 shows the donor electron density obtained in the yz-plane for a negative voltage of -1.0V at the Agate and a donor depth of 20nm. A negative applied voltage causes the electron to disperse in all directions

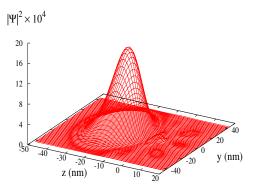


FIG.5: G round state electron density in yz-plane for donor depth at 40nm and voltage at 1V at the A-gate.

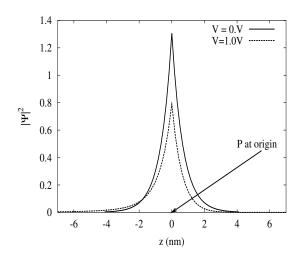


FIG.6: G round state electron density for donor depth at 20nm and voltage at 0. and 1.0V at the A-gate, in the z-direction.

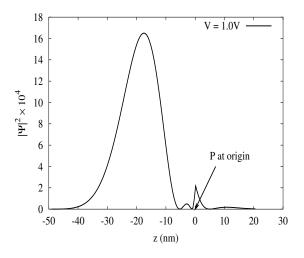


FIG. 7: G round state electron density for donor depth at 40nm and voltage at 1.0V at the A-gate, in the z-direction.

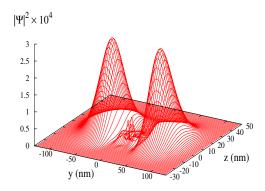


FIG.8: G round state electron density in yz-plane for donor depth at 20nm and voltage at -1.0V at the A-gate.

away from the positive potential, this plot demonstrates that because of the close back gate in the positive zdirection, the electron density predom inantly perturbs away from the applied voltage in either direction laterally.

Because of the interface regions it is either energetically favorable for the donor electron wave function at shallow donor depths to distort completely away from the nucleus, when the gate voltage is negative, or for the donorwave function to be restricted in distorting towards the A-gate, with a positive voltage.

In Table I we present a comparison of the di erence in the ground state energy for the donor wave function without the electric eld (E_0), and with a positive voltage of 1.0V applied to the A-gate ($E_{\rm 1V}$). A lso reported in this table is the TCAD potential at the P nucleus for the varying donor depths.

TABLE I: E $_{1\rm V}$ $\,$ E $_0\,$ for a back gate depth of 60nm .

Q 1 Depth	TCAD Potential	E 1v E 0
	atQ $_1$ (m eV)	(m eV)
20nm	-90.02	-91.70
40nm	-37.06	-47.73

For the close donor depth at 20nm we observe that the energy di erence is approximately equal in magnitude to the TCAD potential at the nucleus. This is because the donor wave function has perturbed only slightly from the zero eld ground state wave function. In contrast the energy di erence for the donor depth at 40nm is much higher as the wave function deform s signi cantly from the ground state wave function towards the applied voltage.

If we compare the results obtained in our work including the e ect of the interface barriers in addition to the electric eld potential, with K ane's results wherein only the potential of a uniform electric eld in the bulk was considered, we observe that the silicon oxide layer and the back gate exert a signi cant in uence on the donor electron's ground state. Instead of the contact hyper ne coupling, A (V), being independent of whether a positive or negative voltage is being applied at the A-gate as reported by K ane, we observe in F ig. 4 that the interface regions in the silicon host geom etry break this symmetry.

E ven w ithout considering the in uence of the interface regions, the e ect of whether a positive or negative voltage is applied at the A-gate causes very di erent changes in the donor electron density. For a positive voltage the electron is bound to both the nucleus and the A-gate. In contrast, when a high enough negative voltage is applied so that the electron is no longer bound to the P nucleus, the electric eld pro le causes the electron to disperse in all directions away from the positive potential.

B. Results obtained varying back gate depth and donor depth

To observe the e ect that the back gate depth has on the donor electron wave function we repeated the calculation with a back gate depth at 100nm. Figure 9 shows the comparison between nuclear resonant frequency shifts of the donor electron with the application of a voltage at the A-gate with a close and far back gate. These calculations were performed with a close back gate at 60nm and a far back gate at 100nm, with a bias of 1.0V at the A-gate and donor depths ranging from 30 to 75nm.

W ith a closer back gate the electric eld strength was higher within the Si wafer, and the donor electron wave function was perturbed greater, and so the frequency shift was more pronounced for donor depths with a close back gate. For donor depths close to the back gate the interface barriere ectively \pushes" the electron towards the A-gate. W ith the back gate at 100nm, the electric

eld strength is lower, and there is no substantial overlap of the donor electron wave function with the back gate barrier for donor depths of 30 and 40nm, so it is not as energetically favorable for the donor electron to perturb aw ay from the back gate tow ard the A-gate.

F igure 10 shows the ground state wave function plotted in the yz-plane for a donor depth of 75nm and with a back gate depth of 100nm and a positive voltage of 1.0V at the A-gate. This plot demonstrates that even at a donor depth far from the A-gate, the ground state wave function distorts freely toward the A-gate because of the close proximity of the back gate, and the remoteness of the silicon oxide interface.

In Table II we present a com parison of the di erence in the ground state energy for the donor wave function without the electric eld, and with a voltage of 1.0V applied to the A-gate, and the back gate at 100nm. A loo reported in this table is the TCAD potential at the P nucleus for the varying donor depths. This table re ects the trend noted in Table I that a signi cantly low er ground state energy is obtained for the deeper donor depths, where

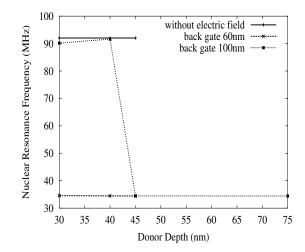


FIG. 9: Nuclear resonant frequency shifts of qubit Q_1 at varying donor depths with back gate depth at 60 and 100nm, and 1.0V at A-gate.

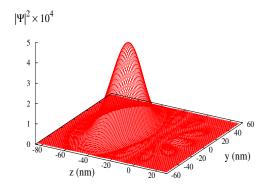


FIG.10: G round state electron density in yz-plane for donor depth at 75nm with back gate depth of 100nm, and 1.0V at A-gate.

the electron density perturbs signi cantly away from the nucleus toward the applied voltage.

TABLE II: E $_{1\rm V}$ $\,$ E $_0$ for a back gate depth of 100nm .

Q ₁ Depth	TCAD Potential	E 1v E 0
	atQ $_1$ (m eV)	(meV)
40nm	-67.25	-68.33
75nm	-26.00	-36.57

V. CONCLUSIONSAND IM PLICATIONS FOR CURRENT FABRICATION TECHNOLOGY AND DEVICE MODELING

We believe that the results reported here using elective m ass theory are quantitatively reasonable. It is reasonable to expect that the variation of the donor wave function with the experimental parameters calculated here using the sm ooth donor envelope function, would be sim - ilar to that of the true wave function.

It is evident that the P donor electron wave function is sensitive to all experimental parameters studied in this paper. The donor wave function exhibits a fundamental change at crucial experimental parameters, where the electron wave function transforms from being only slightly perturbed from the zero eld ground state, to being almost completely perturbed from the nucleus. These results highlight the signi cance of the in uence of the silicon host geometry on the donor electron wave function. O ngoing work in our laboratory is focusing on veri cation of these results, using the full B loch wave structure in our calculations. These results demonstrate the importance of the boundary conditions imposed by the interface regions, and the need to use a basis set which has the exibility to meet the boundary conditions.

However, including the Bloch wave structure, the inter valley term s and the electric eld and interface potentials is a challenging task. The results presented are quantitatively reasonable and provide a fast and reliable method which gives insight into the behavior of the P donor electron wave function under several di erent experimental conditions. To optim ise the fabrication of these devices it is necessary to take into account the dependence of the donor electron wave function on all parameters varied in this paper: donor depth below the A-gate, back gate depth and voltage at the A-gate.

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